

PART D ADDITIONAL INFORMATION FOR APPLICANT WHO IS NOT REQUIRED TO ATTEND WHOLE YEAR STUDY OR IS NOT REQUIRED TO PAY FULL AMOUNT OF TUITION FEES IN THE 2009/10 ACADEMIC YEAR (For reason(s) other than undergoing training/placement/internship, you are required to complete this part.)

(a) (To be completed by applicant)

Reason(s) for not attending whole year study and/or not paying full amount of tuition fees (e.g. suspension/deferment of studies; repeated failed modules; being granted leave of absence etc.)

(b) (To be completed by institution)

This is to certify that the applicant is a registered full-time student of this institution for the 2009/10 academic year.

The amount of tuition fees payable for the 2009/10 academic year is: Amount \$ _____

The applicant's period of attendance in the 2009/10 academic year is (please put a tick in the appropriate box):

1st semester/term only 2nd semester/term only whole year

others (please specify) From _____ to _____

DD/MM/YYYY

DD/MM/YYYY

Signature: _____

Name: _____ Position: _____

Institution: _____ Date: _____

Contact Telephone No./Fax No.: _____

Institution's Chop

PART E LENGTH OF RESIDENCE IN THE HONG KONG SPECIAL ADMINISTRATIVE REGION

I, _____ (Name of Applicant), *have / do not have the right of abode in the Hong Kong Special Administrative Region (Hong Kong). I have resided / have had my home in Hong Kong continuously since the Year _____.

* Please delete if inappropriate.

PART F ADDITIONAL INFORMATION PROVIDED BY APPLICANT

(Please use separate sheets if necessary)

DECLARATION

To be completed by applicant:

I, _____ (Name of Applicant), have read and fully understood the Application Guidance Notes on the Non-means-tested Loan Scheme for Post-secondary Students 2009/10 [NLSPS/1B(2009)](Guidance Notes) and I agree to the terms of, and undertake to abide by the Guidance Notes [and such other requirements as specified from time to time by the Government] if the Government offers me loan(s) under the Non-means-tested Loan Scheme for Post-secondary Students (NLSPS). I declare that the information provided in this application for the NLSPS (which shall include any documents submitted to the Student Financial Assistance Agency (SFAA) in support of the application) (my application) is **complete** and **true** to the best of my knowledge. I am aware that the Government will rely, and consent to the Government relying on the information provided by me to determine the eligibility and the level of loan(s) to be offered to me under the NLSPS. **I also understand that any person who by any deception dishonestly obtains for himself or another any pecuniary advantage shall be guilty of an offence and shall be liable on conviction upon indictment to imprisonment for 10 years under the Theft Ordinance (Chapter 210 of the Laws of Hong Kong).**

I further give my consent to any government departments or private bodies to release my personal data to the SFAA for the purpose of processing this application.

I declare that as at the date of this application: -

- (a) I **have not** obtained any degree[®] or above qualification AND I ACKNOWLEDGE THAT if I have obtained any degree or above qualification, I am **ineligible** to apply for the NLSPS.
- (b) I **have not** completed any degree programme or above qualification in respect of which I will be awarded the qualification after the date of the application. AND I ACKNOWLEDGE THAT if I have completed any degree programme or above qualification in respect of which I will be awarded the qualification after the date of this application, I am **ineligible** to apply for the NLSPS.
- (c) I **have** obtained a locally-accredited sub-degree qualification or I **have** completed a locally-accredited sub-degree programme in respect of which I will be awarded the qualification after the date of the application. AND I ACKNOWLEDGE THAT if the sub-degree qualification which I have obtained is not a locally-accredited one, I am **ineligible** to apply for the NLSPS.
- (d) **(Please put a tick (✓) in the appropriate box below)**
- I am **not** a bankrupt and have **not** applied for Individual Voluntary Arrangement [i.e. the Court has not approved any repayment proposal by me in my capacity as a debtor on how I will repay my creditors] and I am **not** aware of any legal proceedings which have been started (or are pending or being threatened) against me for my bankruptcy or for the appointment of a receiver, administrator, administrative receiver, trustee or similar officer over any or all of my assets.
- I **am** a bankrupt; and/or I **have** applied for Individual Voluntary Arrangement [i.e. the Court is considering or has approved a repayment proposal by me in my capacity as a debtor on how I will repay my creditors] and/or I am aware that legal proceeding(s) has/have been started (or are pending or being threatened) against me for my bankruptcy or for the appointment of a receiver, administrator, administrative receiver, trustee or similar officer over any or all of my assets. I have set out the full details in relation to the above at **Part F – ADDITIONAL INFORMATION PROVIDED BY APPLICANT**.
- (e) **(Please put a tick (✓) in the appropriate box below)**
- I **have never obtained** any grant and/or loan under any financial assistance/loan scheme(s) administered by the SFAA.
- I **have obtained** grant(s) and/or loan(s) under the following financial assistance/loan scheme(s) administered by the SFAA before: -
- Tertiary Student Finance Scheme – Publicly-funded Programmes (TSFS) and/or Local Student Finance Scheme (LSFS)
 - Financial Assistance Scheme for Post-secondary Students (FASP)
 - Non-means-tested Loan Scheme (for full-time tertiary students who are covered under TSFS and/or LSFS)
 - Non-means-tested Loan Scheme for Post-secondary Students
 - Non-means-tested Loan Scheme (for eligible students who are not covered under TSFS and/or LSFS and FASP)

I hereby consent to the Government (including the SFAA and any Government Policy Bureaux and departments) (the Government) and the institution offering the programme in respect of which I am making this application using the personal data or other information provided in my application (including during the course of consideration of such application) for any purpose contemplated in paragraph 15 of Part I of the Guidance Notes and any purpose directly related to such purpose.

I also authorise and consent to my institution [i.e. any institution offering any sub-degree (including Hong Kong Shue Yan University which offers a diploma to its students upon their completion of a 4-year Diploma programme), degree and/or top-up degree programmes] releasing personal data of which I am the subject of the data held by it to the Government in order for the Government to use such information to process my application [and any other application I may make to the Government] and for any other purpose contemplated in paragraph 15 of Part I of the Guidance Notes and any purpose directly related to such purpose.

In particular, I confirm that I authorize the Government to release the results of my application to my institution as mentioned in paragraph 15.3 of Part I of the Guidance Notes.

I understand that the Government has the right to review my application for loan(s) and adjust my loan entitlement(s) or withdraw the Government's offer of loan(s) if necessary. I undertake to refund to the Government any overpayment of loan(s) made to me upon demand.

Should I make a declaration as to not having obtained any degree or above qualification, not having completed any degree programme or above qualification in respect of which I will be awarded the qualification after the date of this application, and having obtained a locally-accredited sub-degree qualification and such declaration is found to be false, I undertake to immediately repay the Government any loan(s) received from the Government pursuant to my application.

I acknowledge that the Government's payment of the loan(s) shall be subject to my honouring all the obligations, conditions, and covenants set out in my application and the other terms by which I am bound under the NLSPS.

Signature of Applicant/HKID No. _____ / _____ Date _____

Declared in Hong Kong.

[®]For the purpose of NLSPS, it refers to a Bachelor Degree qualification.